## Amendments to the Claims

This listing of claims will replace all prior versions, and listings of claims in the application:

## **Listing of Claims:**

Claim 1 (Currently Amended): A method for modeling a semiconductor device process, comprising:

- (a) setting data of an SiO<sub>2</sub> layer;
- (b) setting data of an Si layer brought in contact with said SiO<sub>2</sub> layer;
- (c) setting a plurality of cells in said Si layer, and setting an amount of an impurity included in each of said cells:
- (d) setting an amount per unit time by which said impurity included in each of said cells moves to another cell:
- (e) setting data by which [[said]]  $\underline{a}$  cell in [[the]]  $\underline{a}$  vicinity of an interface of said SiO<sub>2</sub> layer and said Si layer is set as an impurity pileup portion;
  - (f) setting data of a position of a source or a drain in said Si layer; and
- (g) calculating the amount of said impurity included in each of said cells for each unit time after processing said [[the]] steps (a)-(f) (a) through (f),

wherein a mass of said impurity in each of said cells moving to said impurity
pileup portion from each of said cells is determined as an impurity density as a function
of a distance r1 to said impurity pileup portion from each of said cells (hereinafter

referred to as a distance r1), and <u>a function of</u> a distance <u>r2</u> to said source or said drain from each of said cells (hereinafter referred to as a distance r2).

Claim 2 (Original): The method for modeling the semiconductor device process according to claim 1 wherein the data of the position of said source or said drain is set so that said source or said drain is distributed in a predetermined region in said Si layer, and said distance r2 is a distance between each of said cells and said predetermined region.

Claim 3 (Original): The method for modeling the semiconductor device process according to claim 1 wherein the movement mass of said impurity is determined as a function of a solid angle considering each of said cells set as said impurity pileup portion from each of said cells.

Claim 4 (Original): The method for modeling the semiconductor device process according to claim 1, further comprising setting data in which a part of said impurity is generated or disappears for each unit time.

Claim 5 (Currently Amended): The method for modeling the semiconductor device process according to claim 1, wherein said step(f) comprises:

assuming that a plurality of said sources or said drains exist in said Si layer; and

setting data in which the data of [[the]] <u>a</u> position of <u>a</u> specified <u>one of</u> said <u>source</u> sources or [[the]] <u>a</u> data of [[the]] <u>a</u> position of <u>a</u> specified <u>one of</u> said <u>drains</u> [[drain]] is <u>able to be</u> ignored <u>selectively</u>.

Claim 6 (Currently Amended): The method for modeling the semiconductor device process according to claim 1, further comprising:

[[step]](h) storing data [[of]] representing a magnitude of a reverse short channel effect; and a ninth step of

(i) calculating a threshold voltage using the impurity amount calculated [[by]] during said step(g) to calculate a threshold voltage.

Claim 7 (Currently Amended): The method for modeling the semiconductor device process according to claim 1, further comprising a step of setting data of an other insulating layer disposed opposite to said SiO<sub>2</sub> layer via said Si layer.

Claim 8 (New): The method for modeling the semiconductor device process according to claim 1, wherein the function of the distance r1 is

$$\exp(-r1/\lambda 1)$$
,

wherein the function of the distance r2 is

$$\exp(-r2/\lambda 2)$$
, and

wherein  $\lambda 1$ ,  $\lambda 2$  are source and drain process dependent parameters.

Claim 9 (New): The method for modeling the semiconductor device process according to claim 1, wherein the mass of said impurity moving to said pileup portion from each of said cells is determined as a product of the function of the distance r1 and the function of the distance r2.